



In re application of: Chen et al  
 Serial No.: 10/053,785  
 Filed: 01/18/02  
 For: 'Method For Electroplating A Body-Centered Cubic Nickel-Iron Alloy Thin Film With A High Saturation Flux Density'

COMMISSIONER FOR PATENTS  
 ALEXANDRIA, VA 22313-1450

SIR:

Transmitted herewith for the above-identified application are:

- ☒ X Response to Office Action  
☒ X Declaration and Power of Attorney for Patent Application  
☒ X Statement of Added Inventor (37 CFR § 1.48(a)(1))  
☒ X Written Consent of Assignee  
 \_\_\_ No additional fee is required

The fee has been calculated as shown below:

CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDIT. FEE
TOTAL 14 MINUS 14 = 0			x 50 =	\$ .00
INDEP. 1 MINUS 1 = 0			x 200 =	\$ .00
FIRST PRESENTATION OF MULTIPLE DEP. CLAIM			+ 360 =	\$
			Surcharge	\$
			TOTAL	\$ .00

\_\_\_ Please charge my Deposit Account No. 50-2587 in the amount of \$ 0.00.  
 A duplicate copy of this sheet is attached.

☒ X The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 50-2587. A duplicate copy of this sheet is attached.

- \_\_\_ Any filing fees under 37 CFR 1.16 for the presentation of extra claims.  
☒ X Any patent application processing fees under 37 CFR 1.17.

CERTIFICATE OF MAILING

I hereby certify that the above paper/fee is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Commissioner for Patents, Alexandria, VA 22313-1450 on

January 14, 2005  
 Person Mailing paper/fee  
Shaina Yates

Signature

*Shaina Yates*

*Lewis L. Nunnelley*  
 Lewis L. Nunnelley  
 Registration No. 42,942  
 Agent for Applicants  
 Telephone (408) 717-6570  
 Hitachi Global Storage Technologies  
 Intellectual Property Law  
 Dept. NHGB/0142  
 5600 Cottle Road  
 San Jose, CA 95193